

ダイレクトイメージ露光対応ソルダーレジスト

PSR™-4000 D Series

Solder Resist for Direct Imaging Exposure Unit

特徴 **Features**

- 高感度化により短いタクトタイムを実現 Improved productivity due to high sensitivity
- 各種カラーバリエーションに対応可能 Various colors
- 基板の高精度化に貢献 For high accuracy design
- 各種DI露光機に対応 Suitable to various DI exposure units

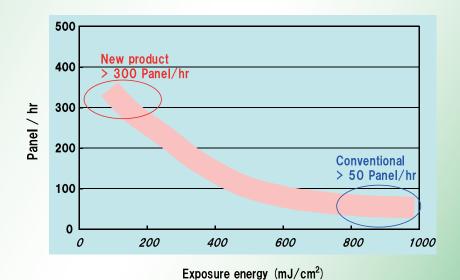
Resolution

Color	Green	Blue	Black	
50µm SR dam Cross section	WHAT SA	all field the speak		SR dam Thickness $21\pm2\mu\mathrm{m}$
ϕ 100 μ m SRO on Cu	SI NAV MCPas SIG NW NAs	St 200 Miles 155 200 200 -	051 20V #50haa 516 10% 27.8 a	SR Thickness 12±2μm

*Exposure: DXP-3512 at ORC 60mJ/cm² (use Cut filter below the 355nm)

Productivity for Black solder resist

Conventional black solder resist we have previously supplied to PCB suppliers required exposure energy of 800~1000mJ/cm².



*Productivity is reference based on our simulation

